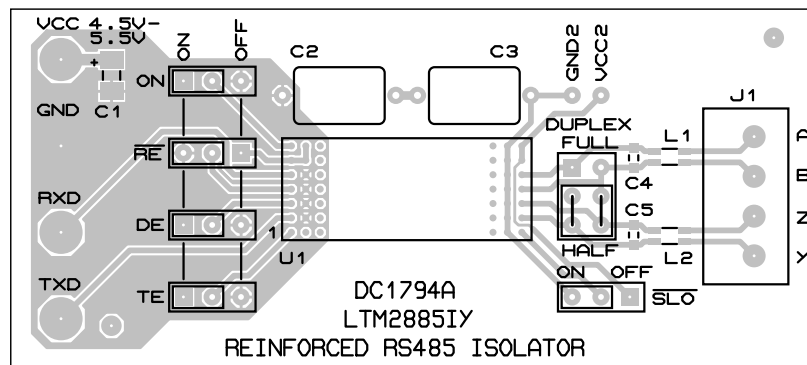


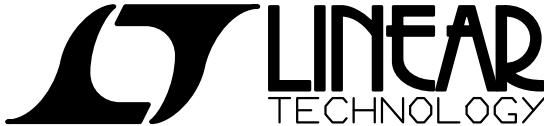
| REVISION HISTORY | | | | |
|------------------|-----|---------------|----------|----------|
| ECO | REV | DESCRIPTION | APPROVED | DATE |
| - | 3 | 3RD PROTOTYPE | KEITH B. | 10-13-14 |

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610
2. MAXIMUM SOLDER TEMPERATURE IS 250 DEGREES CELSIUS
3. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD
4. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
5. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD
7. INSTALL SHUNTS AS SHOWN



TOP SILKSCREEN LAYER
 LINEAR TECHNOLOGY
 DC1794A-3 * LTM2885IY
 REINFORCED RS485 ISOLATOR
 DATE: 10-13-14

| APPROVALS | |  <div> 1630 McCarthy Blvd. Milpitas, CA 95035 Phone: (408) 432-1900 Fax: (408) 434-0507 www.linear.com </div> <div> LTC CONFIDENTIAL FOR CUSTOMER USE ONLY </div> | | |
|---------------|----------|---|---------------------------------|--------------|
| PCB DES. | KEITH B. | | | |
| APP ENG. | KEITH B. | | | |
| | | TITLE: ASSEMBLY DRAWING | | |
| | | REINFORCED RS485 ISOLATOR | | |
| | | SIZE | IC NO. | REV. |
| | | N/A | LTM2885IY DEMO CIRCUIT 1794A | 3 |
| SCALE = 1.5:1 | | DATE: Monday October 13, 2014 | | SHEET 1 OF 1 |